

# CMOS Quad 'D'-Type Flip-Flop

High-Voltage Types (20-Volt Rating)

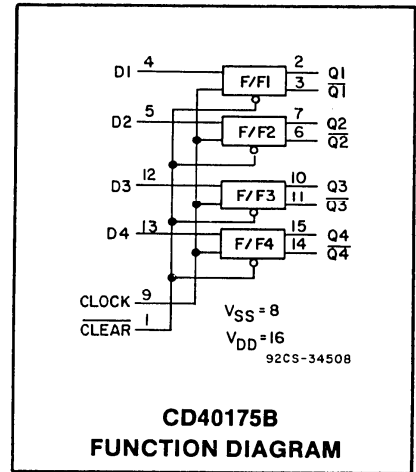
**Features:**

- 100% tested for quiescent current at 20 V
- Maximum input current of 1  $\mu$ A at 18 V over full package-temperature range; 100 nA at 18 V and 25° C
- Noise margin (full package-temperature range) =  
 1 V at  $V_{DD} = 5$  V  
 2 V at  $V_{DD} = 10$  V  
 2.5 V at  $V_{DD} = 15$  V
- 5-V, 10-V, and 15-V parametric ratings

- Meets all requirements of JEDEC Tentative Standard No. 13B, "Standard Specifications for Description of 'B' Series CMOS Devices"
- Output compatible with two HTL loads, two low power TTL loads, or one low power Schottky TTL load
- Functional equivalent to TTL 74175
- Standardized symmetrical output characteristics

**Applications:**

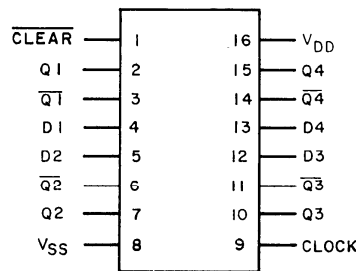
- Shift registers
- Buffer/storage registers
- Pattern generators



The RCA CD40175B consists of four identical D-type flip-flops. Each flip-flop has an independent DATA D input and complementary Q and  $\bar{Q}$  outputs. The CLOCK and CLEAR inputs are common to all flip-flops. Data are transferred to the Q outputs on the positive-going transition of the clock pulse. All four flip-flops are simultaneously reset by a low level on the CLEAR input.

These devices can function as shift register elements or as T-type flip-flops for toggle and counter applications.

The CD40175B is supplied in hermetic dual-in-line ceramic packages (D and F suffixes), 16-lead dual-in-line plastic packages (E suffix), 16-lead ceramic flat packages (K suffix), and in chip form (H suffix).



$V_{DD}$  = PIN 16  
 $V_{SS}$  = PIN 8      92CS-34507

**TERMINAL ASSIGNMENT**

**MAXIMUM RATINGS, Absolute-Maximum Values:**

DC SUPPLY-VOLTAGE RANGE, ( $V_{DD}$ ) (Voltages referenced to $V_{SS}$ Terminal)	-0.5 to $V_{DD} + 20$ V
INPUT VOLTAGE RANGE, ALL INPUTS	-0.5 to $V_{DD} + 0.5$ V
DC INPUT CURRENT, ANY ONE INPUT	$\pm 10$ mA
POWER DISSIPATION PER PACKAGE ( $P_D$ ):	
For $T_A = -40$ to $+60^\circ\text{C}$ (PACKAGE TYPE E)	500 mW
For $T_A = +60$ to $+85^\circ\text{C}$ (PACKAGE TYPE E)	Derate Linearly at 12 mW/ $^\circ\text{C}$ to 200 mW
For $T_A = -55$ to $+100^\circ\text{C}$ (PACKAGE TYPES D, F, K)	500 mW
For $T_A = +100$ to $+125^\circ\text{C}$ (PACKAGE TYPES D, F, K)	Derate Linearly at 12 mW/ $^\circ\text{C}$ to 200 mW
DEVICE DISSIPATION PER OUTPUT TRANSISTOR:	
For $T_A = \text{FULL PACKAGE-TEMPERATURE RANGE (All Package Types)}$	100 mW
OPERATING-TEMPERATURE RANGE ( $T_A$ ):	
PACKAGE TYPES D, F, K, H	-55 to $+125^\circ\text{C}$
PACKAGE TYPE E	-40 to $+85^\circ\text{C}$
STORAGE TEMPERATURE RANGE ( $T_{stg}$ )	-65 to $+150^\circ\text{C}$
LEAD TEMPERATURE (DURING SOLDERING):	
At distance 1/16 $\pm$ 1/32 inch (1.59 $\pm$ 0.79 mm) from case for 10 s max.	$+265^\circ\text{C}$

# CD40175B Types

**RECOMMENDED OPERATING CONDITIONS at TA = 25° C, Except as Noted.**

**For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:**

CHARACTERISTIC	V <sub>DD</sub> (V)	LIMITS		UNITS
		MIN.	MAX.	
Supply-Voltage Range (For TA = Full Package-Temperature Range)	—	3	18	V
Data Setup Time	5	120	—	ns
	10	50	—	
	15	40	—	
Data Hold Time	5	80	—	ns
	10	40	—	
	15	30	—	
Clock Input Frequency	5	—	2	MHz
	10	dc	5	
	15	—	6.5	
Clock Input Rise or Fall Time	5	—	15	μs
	10	—	15	
	15	—	15	
Clock Input Pulse Width	5	250	—	ns
	10	100	—	
	15	75	—	
Clear Pulse Width	5	200	—	ns
	10	80	—	
	15	60	—	
Clear Removal Time	5	250	—	ns
	10	100	—	
	15	80	—	

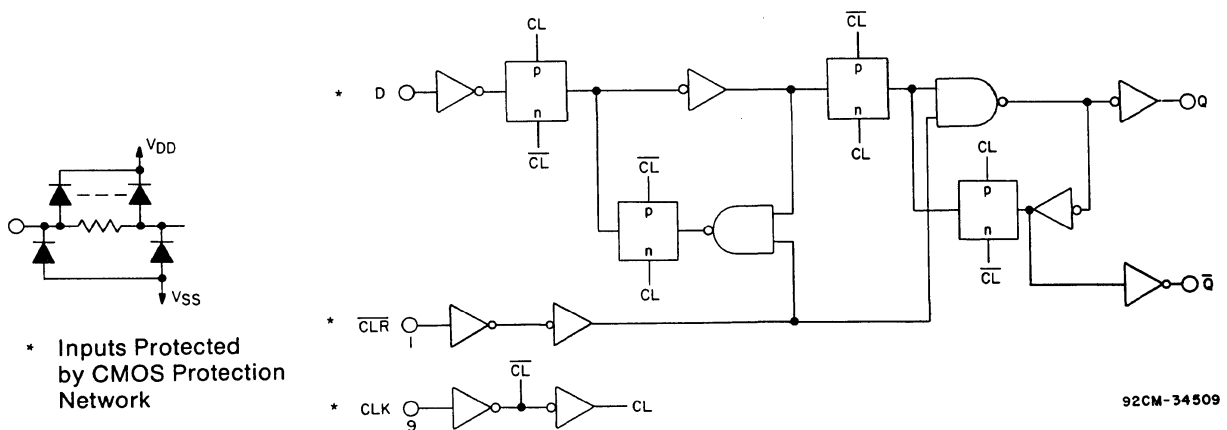


Fig. 1 - Logic diagram (1 of 4 flip-flops).

STATIC ELECTRICAL CHARACTERISTICS

CD40175B Types

CHARACTERISTIC	CONDITIONS			LIMITS AT INDICATED TEMPERATURES (°C)							UNITS			
				Values at -55, +25, +125 Apply to D, F, K, H Packages								+25		
				Vo (V)	Vin (V)	VDD (V)	-55	-40	+85	+125		Min.	Typ.	Max.
Quiescent Device Current Max. $I_{DD}$	—	0, 5	5	1	1	30	30	—	0.02	1	$\mu A$			
	—	0, 10	10	2	2	60	60	—	0.02	2				
	—	0, 15	15	4	4	120	120	—	0.02	4				
	—	0, 20	20	20	20	600	600	—	0.04	20				
Output Low (Sink) Current Min. $I_{OL}$	0.4	0, 5	5	0.64	0.61	0.42	0.36	0.51	1	—	$mA$			
	0.5	0, 10	10	1.6	1.5	1.1	0.9	1.3	2.6	—				
	1.5	0, 15	15	4.2	4	2.8	2.4	3.4	6.8	—				
Output High (Source) Current Min. $I_{OH}$	4.6	0, 5	5	-0.64	-0.61	-0.42	-0.36	-0.51	-1	—	$mA$			
	2.5	0, 5	5	-2	-1.8	-1.3	-1.15	-1.6	-3.2	—				
	9.5	0, 10	10	-1.6	-1.5	-1.1	-0.9	-1.3	-2.6	—				
	13.5	0, 15	15	-4.2	-4	-2.8	-2.4	-3.4	-6.8	—				
Output Voltage: Low-Level Max. $V_{OL}$	—	0, 5	5	0.05				—	0	0.05	$V$			
	—	0, 10	10	0.05				—	0	0.05				
	—	0, 15	15	0.05				—	0	0.05				
Output Voltage: High-Level Min. $V_{OH}$	—	0, 5	5	4.95				4.95	5	—	$V$			
	—	0, 10	10	9.95				9.95	10	—				
	—	0, 15	15	14.95				14.95	15	—				
Input Low Voltage Max. $V_{IL}$	0.5, 4.5	—	5	1.5				—	—	1.5	$V$			
	1, 9	—	10	3				—	—	3				
	1.5, 13.5	—	15	4				—	—	4				
Input High Voltage Min. $V_{IH}$	0.5, 4.5	—	5	3.5				3.5	—	—	$V$			
	1, 9	—	10	7				7	—	—				
	1.5, 13.5	—	15	11				11	—	—				
Input Current Max. $I_{IN}$	—	0, 18	18	$\pm 0.1$	$\pm 0.1$	$\pm 1$	$\pm 1$	—	$\pm 10^{-5}$	$\pm 0.1$	$\mu A$			

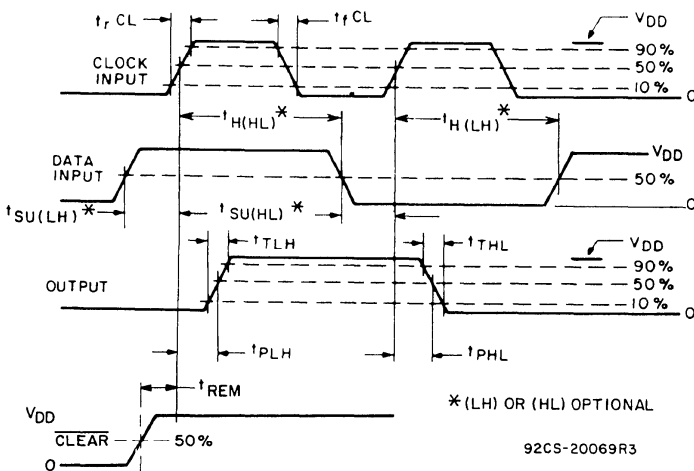


Fig. 2 - Definition of setup, hold, propagation delay, and removal times.

TRUTH TABLE FOR 1 OF 4 FLIP-FLOPS (Positive Logic)

CLOCK	INPUTS		OUTPUTS	
	DATA	$\overline{\text{CLEAR}}$	Q	$\overline{Q}$
—	0	1	0	1
—	1	1	1	0
—	X	1	Q	$\overline{Q}$
X	X	0	0	1

1=High Level      X=Don't Care      0=Low Level

# CD40175B Types

DYNAMIC ELECTRICAL CHARACTERISTICS at  $T_A = 25^\circ\text{C}$ ; Input  $t_r, t_f = 20\text{ ns}$ ,  $C_L = 50\text{ pF}$ ,  $R_L = 200\text{ k}\Omega$

CHARACTERISTIC	TEST CONDITIONS $V_{DD}$ (V)	LIMITS			UNITS
		MIN.	TYP.	MAX.	
Transition Time $t_{THL}, t_{TLH}$	5	—	100	200	ns
	10	—	50	100	
	15	—	40	80	
Propagation Delay Time Clock to Q Output $t_{PHL}, t_{PLH}$	5	—	220	400	
	10	—	90	160	
	15	—	70	120	
Propagation Delay Time $\overline{\text{CLEAR}}$ to Q Output $t_{PHL}$	5	—	325	500	
	10	—	130	200	
	15	—	100	150	
Minimum Pulse Width Clock $t_{WH}$	5	—	110	250	
	10	—	45	100	
	15	—	35	75	
$\overline{\text{Clear}}$ $t_{WL}$	5	—	100	200	
	10	—	40	80	
	15	—	30	60	
Maximum Clock Frequency $f_{CL}$	5	2	4.5	—	MHz
	10	5	11	—	
	15	6.5	14	—	
Maximum Clock Rise or Fall Time $t_{rCL}, t_{fCL}$	5	15	—	—	$\mu\text{s}$
	10	15	—	—	
	15	15	—	—	
Minimum Data Setup Time $t_{SU}$	5	—	60	120	ns
	10	—	25	50	
	15	—	20	40	
Minimum Data Hold Time $t_H$	5	—	40	80	
	10	—	20	40	
	15	—	15	30	
Minimum Clear Removal Time ‡ $t_{REM}$	5	—	125	250	
	10	—	50	100	
	15	—	40	80	
Input Capacitance $C_{IN}$	—	—	5	7.5	pF

‡  $\overline{\text{CLEAR}}$  signal must be high prior to positive-going transition of CLOCK pulse.

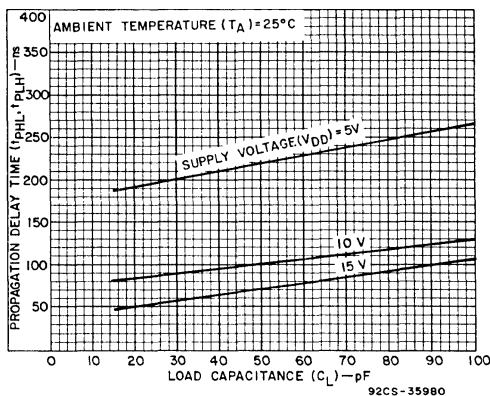


Fig. 3 - Typical propagation delay time (CLOCK to OUTPUT) as a function of load capacitance.

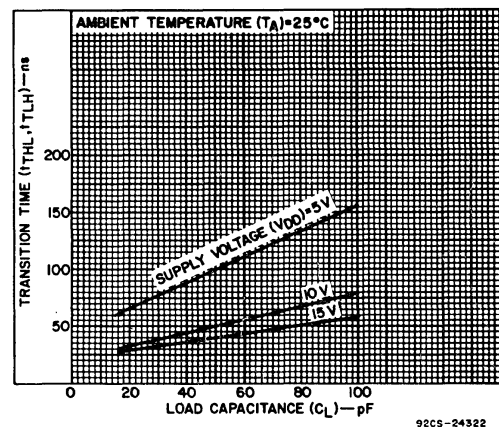


Fig. 4 - Typical transition time as a function of load capacitance.

# CD40175B Types

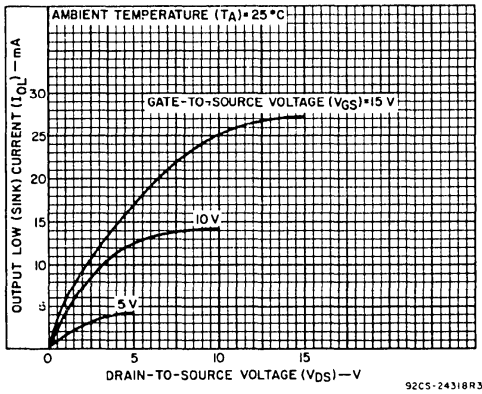


Fig. 5 - Typical output low (sink) current characteristics.

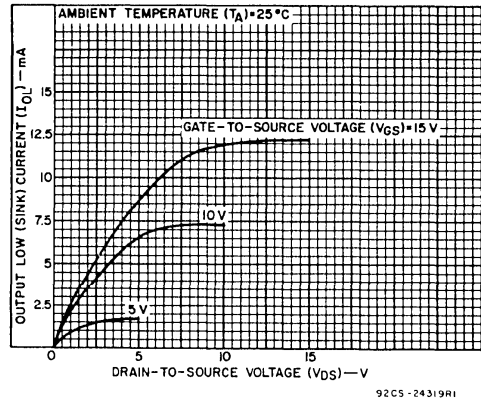


Fig. 6 - Minimum output low (sink) current characteristics.

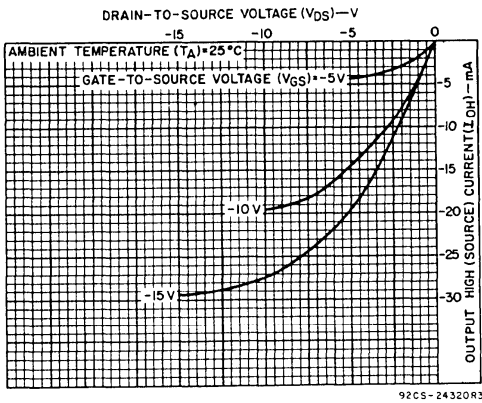


Fig. 7 - Typical output high (source) current characteristics.

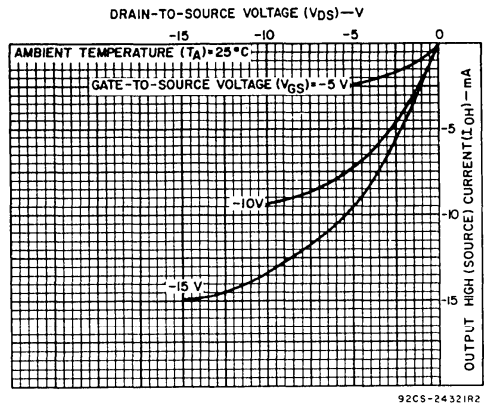


Fig. 8 - Minimum output high (source) current characteristics.

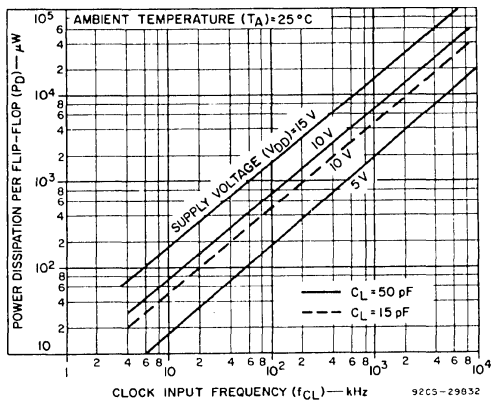


Fig. 9 - Typical dynamic power dissipation as a function of CLOCK frequency.

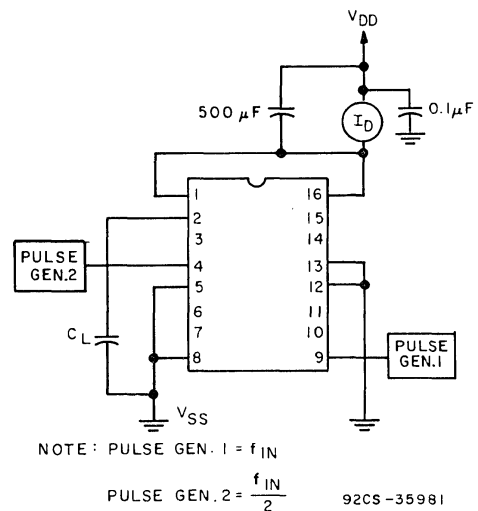


Fig. 10 - Dynamic power dissipation test circuit.

# CD40175B Types

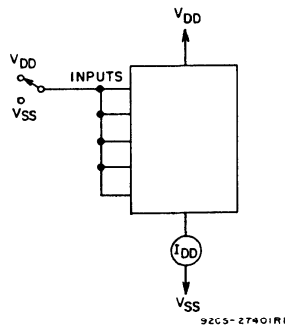


Fig. 11 - Quiescent device current test circuit.

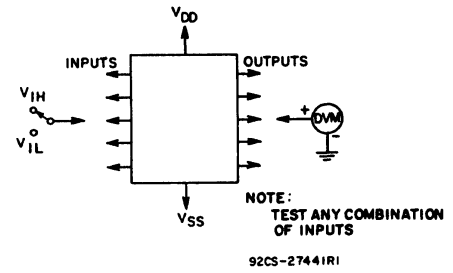


Fig. 12 - Noise immunity test circuit.

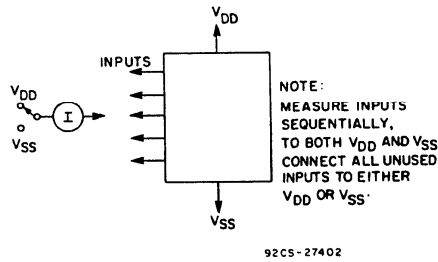
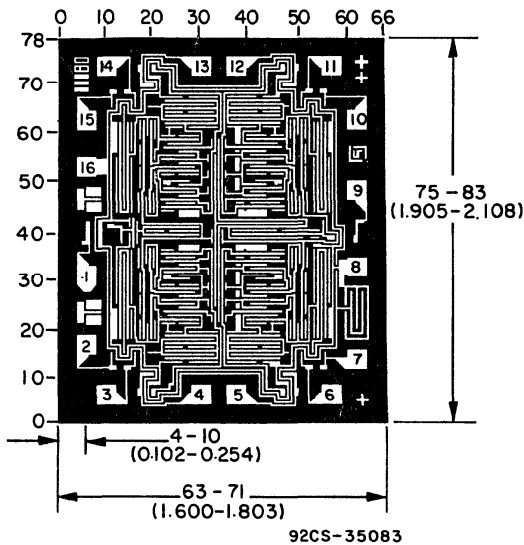


Fig. 13 - Input leakage current test circuit.



Dimensions and pad layout for CD40175BH.

Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils ( $10^{-3}$  inch).

The photographs and dimensions of each CMOS chip represent a chip when it is part of the wafer. When the wafer is separated into individual chips, the angle of cleavage may vary with respect to the chip face for different chips. The actual dimensions of the isolated chip, therefore, may differ slightly from the nominal dimensions shown. The user should consider a tolerance  $-3$  mils to  $+16$  mils applicable to the nominal dimensions shown.